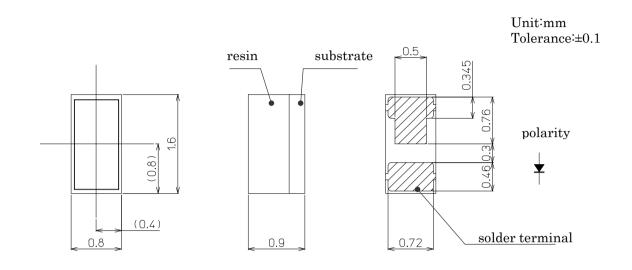
		of Application e specifications are applied to	the chip ty	vpe LED la	amp , moo	del CL-824	l-MU1W1-T
	2. Part c		00	1 - \ \T	TT1 \\	/1 - T	
		Series 824 : White LED for genera	824			<u> </u>	
		Special specifications M : General Color Rende	ering Index	тур. 85 7	Гуре.		
		Watt Class U1 : Under 1 watt packag	ge.				
		Lighting color	ated Color	Temperat	ure 4000	(K)	
		Shipping mode					
_			Approved	Checked	Drawn	Symbol	CITILIGHT
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rk	Date	Description Appro.		OIDIZED		Drawing No RONICS (

3. Outline drawing



4. Performance

(1) Absolute Maximum Rating	g			_
	Parameter	Symbol	Rating Value	Unit	
	Power Dissipation	Pd	108	mW	
	Forward Current	$I_{\rm F}$	30	mA	
	Forward Pulse Current	$I_{\rm FP}$	100 *	mA	*1
	Reverse Voltage	V _R	5	V	
	Operating Temperature	T _{OP}	$-30 \sim +85$	С	
	Storage Temperature	T_{ST}	-40 ~ +100	С	
	Junction Temperature	Tj _{Max}	120	С	*2

*1Forward Current : Duty≤1/10 , Pulse Width≤0.1msec

*2 D.C. Current : Tj = Tc + Rj-c x Pd Pulse Current : Tj = Tc + Rj-c x Pw(Power Dissipation / one-Pulse) x duty Ts:Temperature of anode solder terminal

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(2) Electro-optical	Characte	ristics				(Tc=25°C
Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
Forward Voltage	$V_{\rm F}$	I _F =20mA	2.8	3.2	3.5	V
Reverse Current	I_R	V _R =5V	-	-	100	μA
Thermal resistance	R_{J-s}	Junction-solder	-	175	-	C/W
uminous Intensity	Iv	I _F =20mA	1240	1650	-	mcd
Luminous Flux	$\phi_{\rm V}$	I _F =20mA	-	(4.5)	-	lm
High General Color Rendering Index	Ra	I _F =20mA	80	85	-	-

*1 In accordance with NIST standard

Ranking (Condition : I_F =20mA , T_a =25C)

Parameter	Symbol	Rank	MIN	MAX	Unit
		Q	2.8	3.0	
Forward Voltage	$V_{\rm F}$	R	3.0	3.2	V
		\mathbf{S}	3.2	3.5	
		В	1240	1405	
Luminous Intensity	I_v	С	1405	1900	mcd
		D	1900	2066	

Chromaticity coordinates

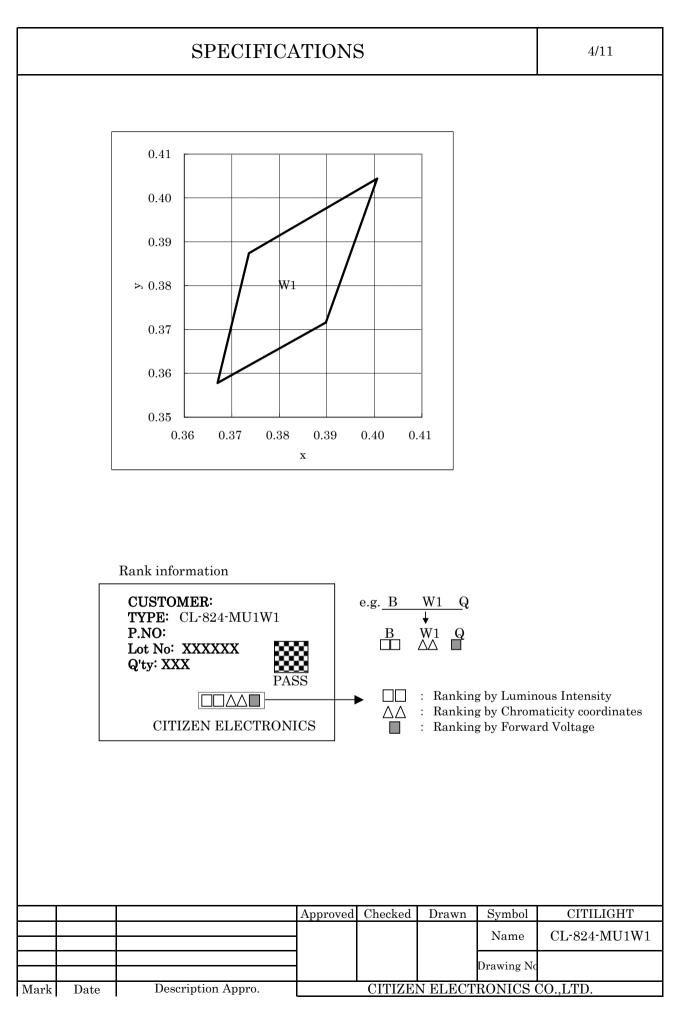
(Con	di	tion	: IF	`=20m	A ,Tc	=25C)	
	2		1					

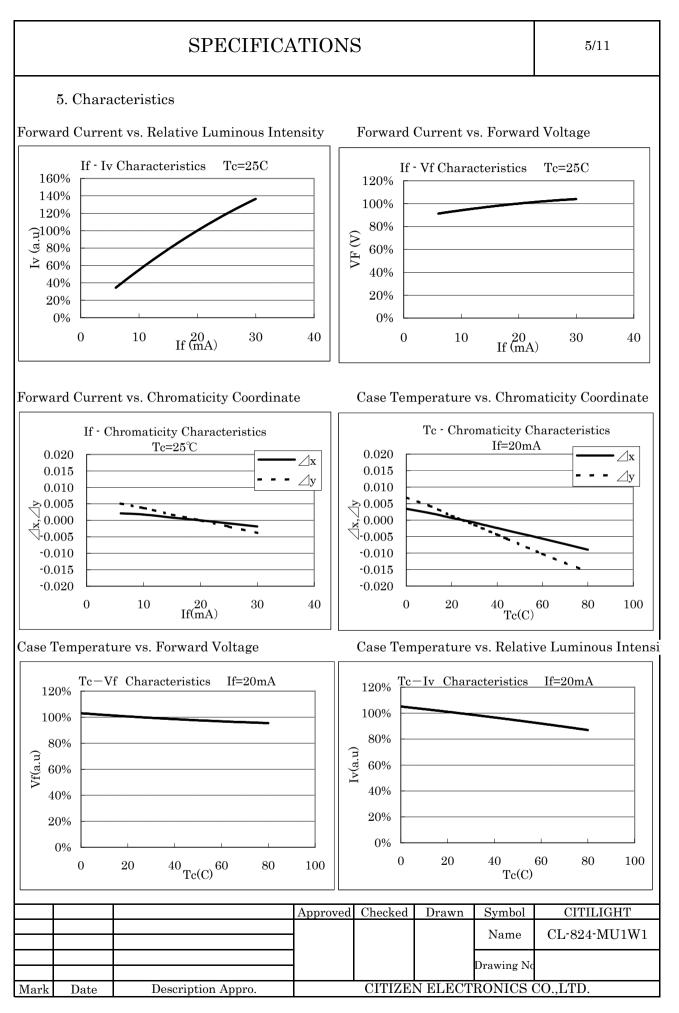
Color Rank	x	У
	0.4006	0.4044
W1	0.3736	0.3874
	0.3670	0.3578
	0.3898	0.3716

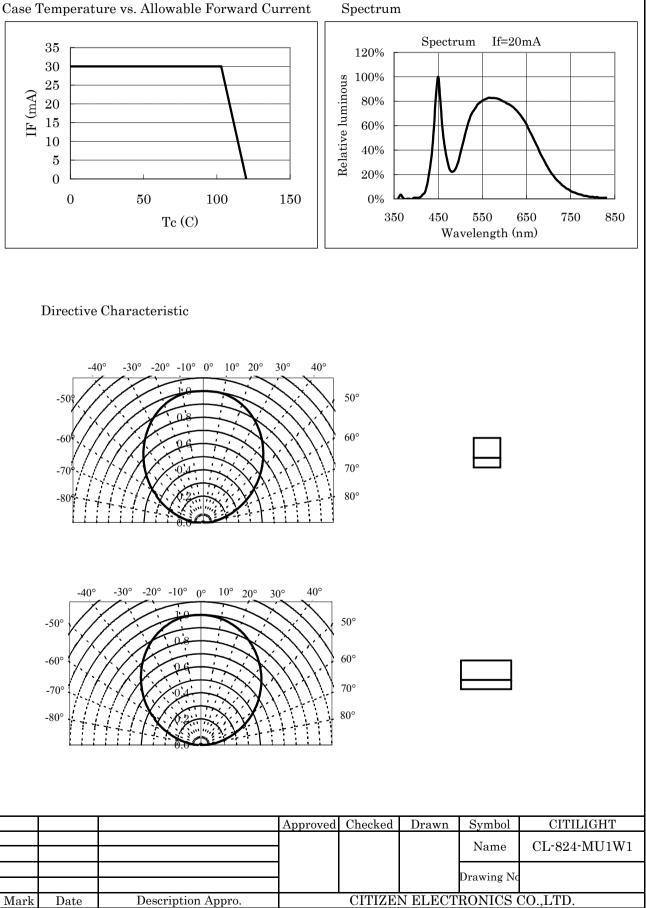
Note 1) The tolerance of measurement at our tester is VF±3%, $\varphi v\pm 10\%$, Chromaticity(x,y)±0.01. Note 2) For handling ,please apply CMOS LSI or equivalent any electrostatic effect.

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)







Mark

Date

Description Appro.

Ref.CE-P417 03/09 R1(0309)

6. Reliability

(1)Details of the tests

Test Item	Test Condition
Life Test in Continuous Operation	25±3C, $\mathrm{I_F}\!\!=\!\!20~\mathrm{mA}$, 1000+24/-12 hours
Low Temperature Storage Test	-40+3/-5C , 1000+24/-12hours
High Temperature Storage Test	100+5/-3C , 1000+24/-12hours
Moisture-proof Test	60 ± 2 °C, $90 \pm 5\%$ RH for $1000+24/-12$ hours
Thermal Shock Test	-40C , 30 minutes and 100C , 30 minutes, 100cycle
Solder Heat Resistance Test	Recommended temperature profile (reflow soldering) × 2, (2nd test must be started after the samples

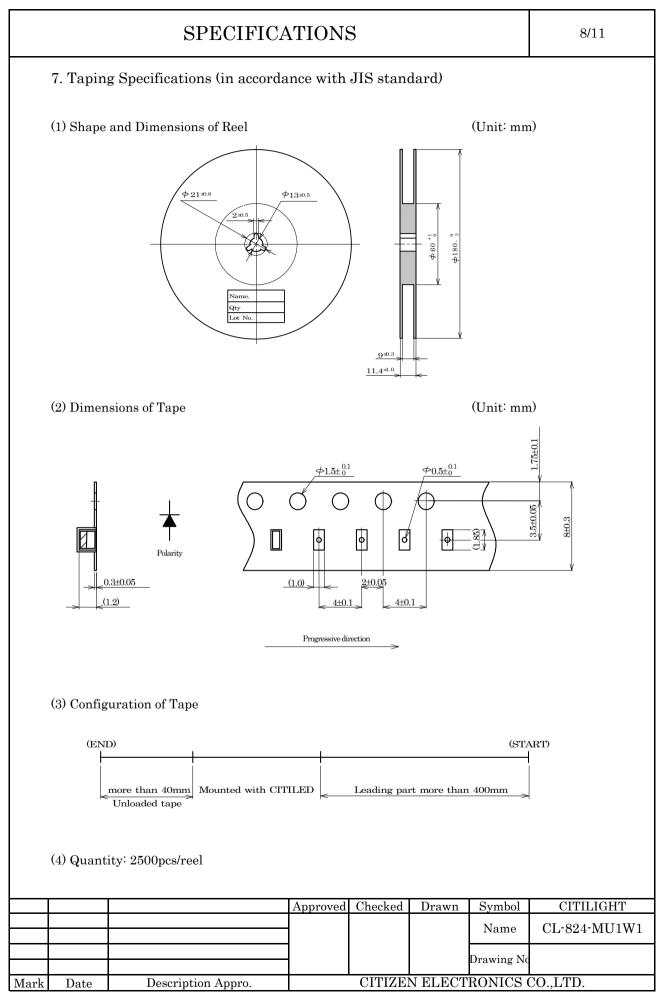
(2)Judgment Criteria of Failure for Reliability Test	ent Criteria of Failure for Reliability Test	(Ta
--	--	-----

(2)Judgment Crite	Γest (Ta=25C)		
Measuring Item	Symbol	Measuring Condition	Judgment Criteria for Failure
Forward Voltage	$V_{\rm F}$	I _F =20mA	>U×1.2
Reverse Current	I_{R}	$V_R=5V$	>U×2
Luminous Intensity	I_V	I _F =20mA	<s×0.7< td=""></s×0.7<>

U defines the upper limit of the specified characteristics.S defines the initial value.

Note: Measurement shall be taken between 2 hours and 24 hours, and the test pieces should be returned to the normal ambient conditions after the completion of each test.

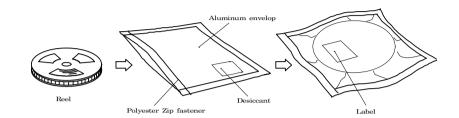
			Approved	Checked	Drawn	Symbol	CITILIGHT
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						Drawing No	
Mark	Date	Description Appro.		CITIZEI	N ELECT	RONICS (CO.,LTD.



8. Packing Specifications

8-1. Moisture-proof Packing

To prevent moisture absorption during transportation and storage, reels are packed in aluminum envelopes which contain a desiccant with a humidity indicator.



8-2. Storage

To prevent moisture absorption, it is strongly recommended that reels (in bulk or taped) should be stored in the dry box (or the desiccator) with a desiccant as the appropriate storage place. If not, the following is recommended.

Temperature:	5~30C
Humidity:	60%RH max

The devices should be mounted as soon as possible after unpacking. If you store the unpacked reels, please store them in the dry box or seal them into the envelop again.

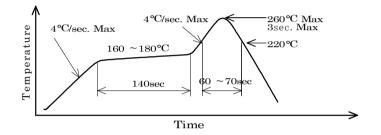
			Approved	Checked	Drawn	Symbol	CITILIGHT
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Mark	Date	Description Appro.		CITIZE	N ELECT	RONICS (CO.,LTD.

9. Precautions

9-1. Soldering

(1) Lead free solderin

- Following soldering paste is recommended Melting temperature: 216 ~ 220°C. Composition: Sn 3.5Ag 0.75Cu
- 2) The temperature profile at the top surface of the parts is recommended as shown below.
- 3) It is requested that products should be handled after their temperature has dropped down to the normal room temperature



9-2. Washing

(1) When washing after soldering is needed, following conditions are requested.

a) Washing solvent: Pure Water

b) Temperature, time: 50C or less \times 30 seconds max. or 30C or less \times 3 minutes max.

c) Ultrasonic washing: 300W or less

9-3. Other directions

(1) It is requested to avoid any stress added to the resin portion while it is heated.

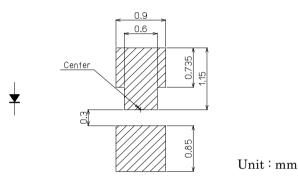
(2) It is requested to avoid any friction by sharp metal nail etc. to the resin portion.

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10. Designing precautions

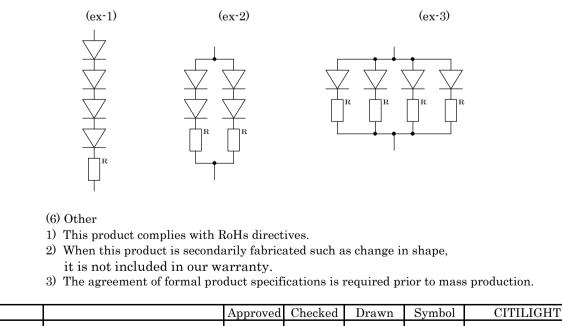
- (1) The current limiting resistor should be placed in the circuit so that is driven within its rating. Also avoid reverse voltage (over-current) applied instantaneously when ON or OFF.
- (2) When pulse driving current is applied, average current consumption should be within the rating. Also avoid reverse voltage applied when put off.
- (3) Recommended soldering pattern

<For reflow soldering>



The above dimensions are not the one which guarantee the performance of mountability. The use of the above pattern is recommended to use after deep study at your site.

- (4) When assembling the circuit board into the finished products, care must be taken to avoid the component parts from touching other parts.
- (5) When using multiple LEDs, it is required to connect a current limiting resistor on each path which the current flows to the LEDs.



						Name	CL-824-MU1W1
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